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Final Terms of the Sixtieth Series Unsecured Bonds

Toshiba Corporation announced today that it has determined the terms of the Sixtieth Series Unsecured Bonds (with inter-bond *pari passu* clause), all of which will be offered and issued in Japan.

The terms of the issues are as follows:

The Sixtieth Series Unsecured Bonds (with inter-bond *pari passu* clause)

1. Total amount of issue: 30 billion yen
2. Denomination of each Bond: 500 thousand yen
3. Interest rate: 0.40% per annum
4. Issue price: 100% of the denomination of each bond
5. Redemption price: 100% of the denomination of each bond
6. Term: 4 years
7. Maturity date: July 25, 2018
8. Offering period: From July 14, 2014 to July 24, 2014
9. Payment date: July 25, 2014
10. Ratings: A- (Rating and Investment Information, Inc.)
11. Commissioned Companies:
Mizuho Bank, Ltd.
Sumitomo Mitsui Banking Corporation
The Bank of Tokyo-Mitsubishi UFJ, Ltd .
Sumitomo Mitsui Trust Bank, Limited

Note: This notice is intended as general information regarding Toshiba Corporation's issuance of straight bonds and shall not be considered an offering of securities. This notice shall not be construed as an offering of securities in any region including the United States or Canada. The securities have not been and will not be registered under the Securities Act of 1933, as

amended (the “Securities Act”), and may not be offered or sold in the United States absent registration or an applicable exemption from the registration requirements under the Securities Act.